

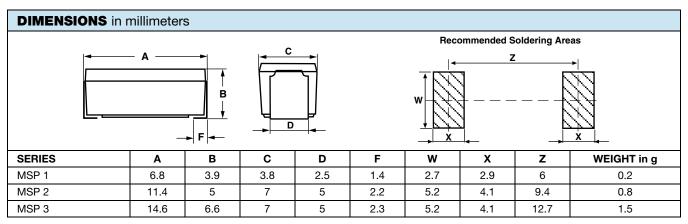
Precision Surface Mount Resistors Wirewound or Metal Film Technologies



FEATURES

- According to EN 140402-801 (wirewound)
- Wide range of ohmic values (0.04 Ω to 1 M Ω)
- Low temperature coefficient (± 25 ppm/°C available)
- · Good electrical insulation
- All welded construction and molded encapsulant
- High power ratings (up to 2.5 W)
- Stability class 0.5
- Pure matte tin termination
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Specially designed for surface mounting, the MSP series uses either wirewound or metal film technology. The molded package ensures mechanical and climatic protection as well as high dielectric insulation. The MSP design is compatible with surface mounting equipment and can withstand wave and reflow soldering techniques.



Note

General tolerance: ± 0.2 mm

STANDARD ELECTRICAL SPECIFICATIONS							
MODEL	RESISTANCE RANGE Ω	RATED POWER P _{25 °C} W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C		
MSP 1 B	0.04 to 2.2K	1	50	0.5, 1, 2, 5	25, 50, 100		
MSP 2 B	0.04 to 4.7K	2	120	0.5, 1, 2, 5	25, 50, 100		
MSP 3 B	0.04 to 13K	2.5	200	0.5, 1, 2, 5	25, 50, 100		
MSP 1 C	10 to 332K	0.5	300	0.5, 1	25, 50		
MSP 2 C	10 to 1M	1	350	0.5, 1	25, 50		



Vishay Sfernice

TECHNICAL SPECIFICATIONS							
RESISTIVE TECHNOLOGY			WIREWOUND		METAL FILM		
Vishay Sfernice Series		MSP 1 B	MSP 2 B	MSP 3 B	MSP 1 C	MSP 2 C	
Metric Size		0704M	1107M	1607M	0704M	1107M	
Rated Dissipation at +25 °C, P ₂₅		1 W	2 W	2.5 W	0.5 W	1 W	
	± 5 % E24 Series	0.04 to 2.2K	0.04 to 4.7K	0.04 to 13K	-	-	
Ohmic Range in Relation to Tolerance	± 2 % E48 Series	0.1 to 2.2K	0.04 to 4.7K	0.05 to 13K	-	-	
(with Prefered Ohmic Value Series)	± 1 % E96 Series	0.1 to 2.2K	0.04 to 4.7K	0.05 to 13K	10 to 332K	10 to 1M	
	± 0.5 % E96 Series	1.4 to 2.2K	0.4 to 4.7K	0.3 to 13K	10 to 332K	10 to 1M	
Limiting Element Voltage	Limiting Element Voltage, U _{max.} AC/DC		120 V	200 V	300 V	350 V	
Series		MSP 1 B	MSP 2 B	MSP 3 B	MSP 1 C	MSP 2 C	
Critical Resistance		-	-	-	180K	122.5K	
Temperature Coefficient		CECC 40402-801 -55 °C / +200 °C < 1 Ω ± 100 ppm/°C 1 Ω to < 10 Ω ± 50 ppm/°C ≥ 10 Ω ± 25 ppm/°C		-55 °C / +155 °C 10 Ω to 332 kΩ K3: ± 50 ppm/°C K4: ± 25 ppm/°C > 332 kΩ			
Failure Rate		E6 10 ⁻⁶ /h	E6 10 ⁻⁶ /h	E0 or A 10 ⁻⁴ /h	-	-	

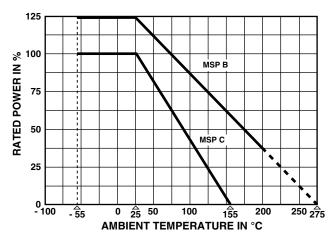
MECHANICAL SPECIFICATIONS					
RESISTIVE TECHNOLOGY	Wirewound	Metal Film			
Encapsulant	Thermoset				
Resistive Element	CuNi or NiCr	NiCr or NiP			
Ceramic Substrate	Alumina or Steatite	Alumina			
Termination Electrolytic pure matte tin					

ENVIRONMENTAL SPECIFICATIONS						
RESISTIVE TECHNOLOGY	Wirewound	Metal Film				
Temperature Range	-55 °C to 275 °C	-55 °C to 155 °C				
Climatic Category (LCT/UCT/days)	55/200/56	55/125/10				



	COND	ITIONS	REQUIREMENTS		
TESTS	Wirewound	Metal Film	Wirewound EN 140402-801	Metal Film	
Short Time Overload		0115-1 2 <i>U</i> _{max.} /5 s	± (0.25 % + 0.05 Ω)	± 0.25 %	
Load Life	90'/30' 1000 h <i>F</i>	0115-1 cycles ₇ + 25 °C h <i>P</i> _r	± (0.5 % + 0.05 Ω) ± (3 % + 0.05 Ω)	± 1 %	
Dielectric w/s Voltage	IEC 60 U _{RMS} = 5	0115-1 00 V/60 s	No flashover or Leakage curre		
Rapid Change of Temperature	IEC 60115-1 IEC 60068-2-14 Test Na 5 cycles (30' at LCT/30' at UCT)		± (0.25 % + 0.05 Ω)	± 0.25 %	
	-55 °C / +200 °C	-55 °C / +125 °C			
Climatic Sequence	-55 °C / +200 °C	-55 °C / +125 °C	± (0.5 % + 0.05 Ω)	± 0.5 %	
Humidity (Steady State)	IEC 60115-1 IEC 60068-2-3 Test Ca 95 % HR/40 °C 56 days 10 days		± (0.5 % + 0.05 Ω)	± 1 %	
Substrate Bending Test	IEC 60115-1 IEC 60068-2-21 Test <i>U</i> _{e3} 2 mm/10 times		± (0.25 % + 0.05 Ω)	± 0.25 %	
Shock	IEC 60115-1 IEC 60068-2-27 Test Ea 50 g's/half sine/3 times by direction (i.e. 18 shocks)		± (0.25 % + 0.05 Ω)	n/a	
Vibration	IEC 60115-1 IEC 60068-2-6 Test Fc 10 Hz/2000 Hz 10 Hz/500 Hz		± (0.25 % + 0.05 Ω)	± 0.25 %	
Resistance to Soldering Heat	IEC 60115-1 IEC 60068-2-58 Solder bath 260 °C/10 s		± (0.5 % + 0.05 Ω)	n/a	

POWER RATING

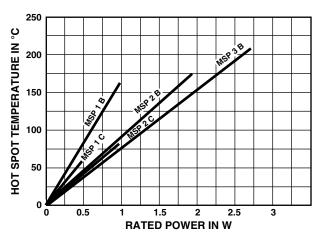


SURFACE MOUNTING OF MSP B

Soldering cycle: 2 min at 215 °C or 10 s at 260 °C or with an iron 40 W: 3 s at 350 °C.

Soldering is possible by wave, reflow and vapor phase.

TEMPERATURE RISE



NON INDUCTIVE WINDING FOR MSP B

Non-inductive (Ayrton Perry) winding available. Please consult Vishay Sfernice.



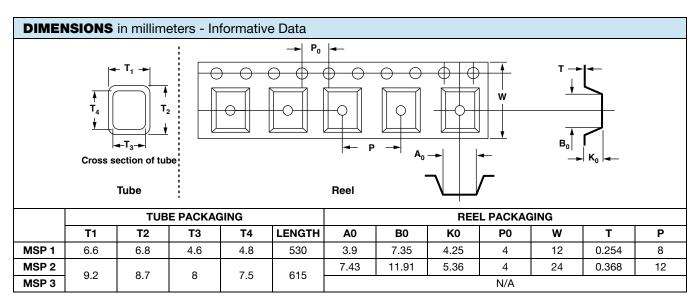
PACKAGING

In bulk (plastic bag of 100 units or multiples)

In tube: MSP1 70 units per tube

MSP2 50 units per tube MSP3 40 units per tube

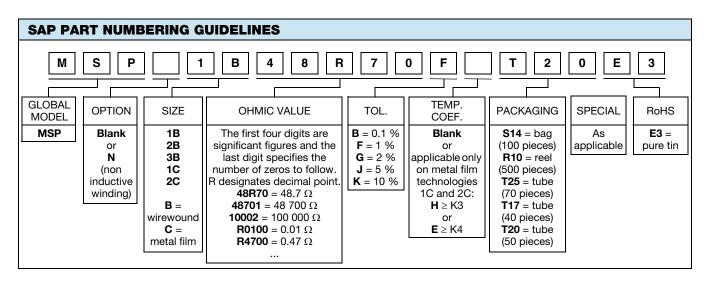
In reel of 500 units for MSP1 and MSP2



MARKING

Vishay Sfernice trademark, ohmic value (in Ω), tolerance (in %), series and style, technology, manufacturing date.

ORDERING INFORMATION									
MSP	1	В		48U7	± 1 %	TC	BA100	e3	
SERIES	STYLE	TECHNOLOGY B: Wirewound C: Metal Film	NON INDUCTIVE WINDING Optional	OHMIC VALUE	TOLERANCE	Applicable only in "C" technology	PACKAGING	LEAD (Pb)-FREE	





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